

**FEATURES**

$R_{DS(ON)} \leq 39m \Omega @V_{GS}=10V$

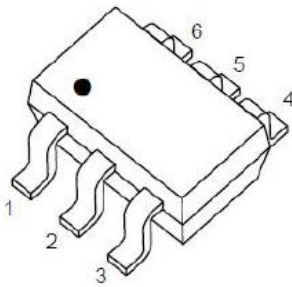
$R_{DS(ON)} \leq 52m \Omega @V_{GS}=4.5V$

**APPLICATIONS**

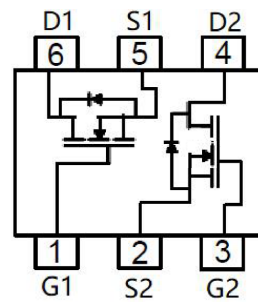
DC - DC Converter

Load Switch

**SOT-23-6L**



**N-CHANNEL MOSFET**



**Maximum ratings (T<sub>c</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	Drain-Source Voltage	T <sub>C</sub> = 25 °C	30	-	V
V <sub>GS</sub>	Gate-Source Voltage	T <sub>C</sub> = 25 °C	-	± 20	V
I <sub>D</sub> *	Drain Current	T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	3.6	A
I <sub>DM</sub> <sup>*,**,***</sup>	Pulsed Drain Current	T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	15	A
P <sub>tot</sub> *	Total Power Dissipation	T <sub>C</sub> = 25 °C	-	0.83	W
T <sub>stg</sub>	Storage Temperature		- 55	150	°C
T <sub>J</sub>	Junction Temperature		-	150	°C
R <sub>θJA</sub> *	Thermal Resistance- Junction to Ambient		-	150	°C / W

Notes:

- \* Surface Mounted on 1 in<sup>2</sup> pad area, t ≤ 10 sec
- \*\* Pulse width ≤ 10 μs, duty cycle ≤ 1 %
- \*\*\* limited by bonding wire

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 250\ \mu\text{A}$	30	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = 250\ \mu\text{A}$	1.0	1.5	2.2	V
$I_{DSS}$	Drain Leakage Current	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	-	-	$\pm 100$	nA
$R_{DS(on)}^a$	Channel On-State Resistance	$V_{GS} = 10\text{ V}, I_D = 3.6\text{ A}$	-	30	39	m $\Omega$
		$V_{GS} = 4.5\text{ V}, I_D = 3\text{ A}$	-	40	52	
<b>Diode Characteristics</b>						
$V_{SD}^a$	Diode Forward Voltage	$I_{SD} = 3.6\text{ A}, V_{GS} = 0\text{ V}$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 3.6\text{ A}, dI_{SD}/dt = 100\text{ A}/\mu\text{s}$	-	7.5	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	2.5	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 15\text{ V}$ Frequency = 1 MHz	-	230	-	pF
$C_{oss}$	Output Capacitance		-	40	-	
$C_{rss}$	Reverse Transfer Capacitance		-	17	-	
$t_d(on)$	Turn-on Delay Time	$V_{DS} = 10\text{ V}, V_{GEN} = 4.5\text{ V},$ $R_G = 6\ \Omega, I_{DS} = 3.6\text{ A}$	-	10	-	ns
$t_r$	Turn-on Rise Time		-	50	-	
$t_d(off)$	Turn-off Delay Time		-	10	-	
$t_f$	Turn-off Fall Time		-	20	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{GS} = 10\text{ V}, V_{DS} = 15\text{ V},$ $I_{DS} = 3.6\text{ A}$	-	5.0	-	nC
$Q_{gs}$	Gate-Source Charge		-	1.0	-	
$Q_{gd}$	Gate-Drain Charge		-	1.3	-	

**Notes:**a : Pulse test ; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ 

b : Guaranteed by design, not subject to production testing

### Typical Performance Characteristics

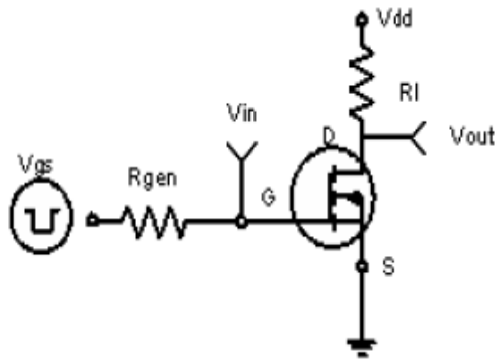


Figure1:Switching Test Circuit

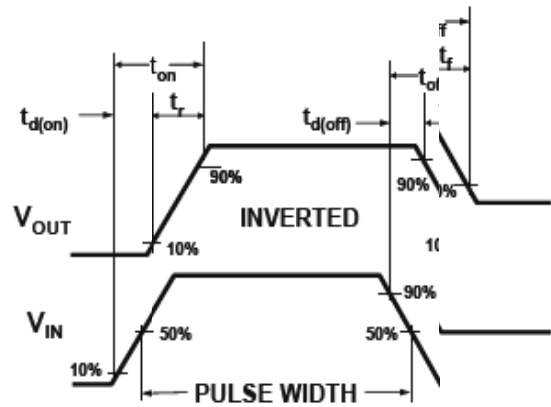
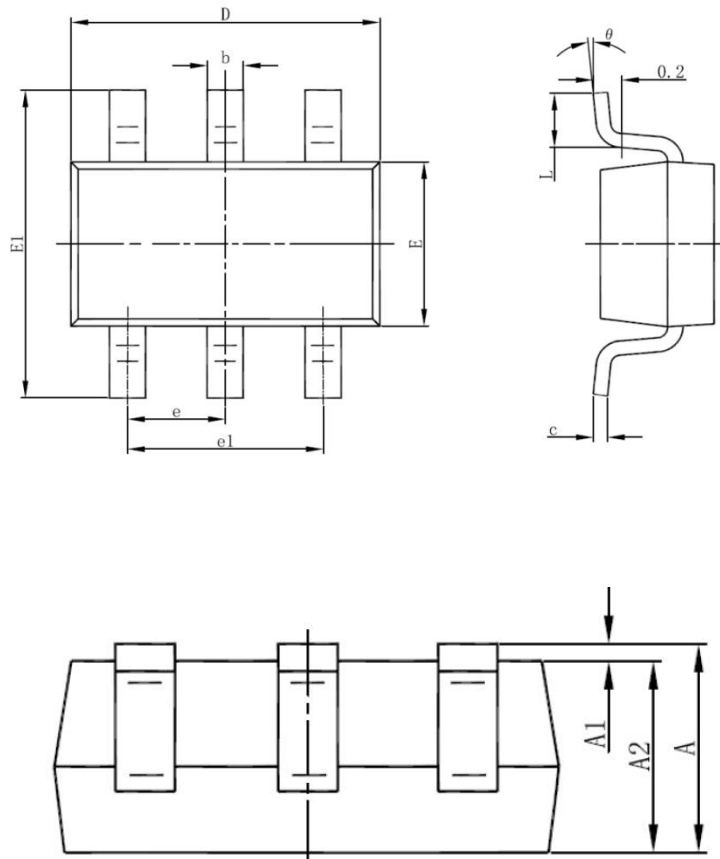


Figure2:Switching Waveforms

SOT-23-6L package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°